## TRADEMARK ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the the name of the receiving party by deleting Microsense Holdings, LLC and substituting Microsense, LLC previously recorded on Reel 004103 Frame 0873. Assignor(s) hereby confirms the assignment of the entire interest.

### **CONVEYING PARTY DATA**

Name	Formerly	Execution Date	Entity Type
KLA-Tencor Corporation		11/12/2009	CORPORATION: DELAWARE

## **RECEIVING PARTY DATA**

Name:	MicroSense LLC
Street Address:	1 Van DeGraaff Drive
City:	Burlington
State/Country:	MASSACHUSETTS
Postal Code:	01803
Entity Type:	LIMITED LIABILITY COMPANY: DELAWARE

## PROPERTY NUMBERS Total: 4

Property Type	Number	Word Mark
Registration Number:	0982523	MICROSENSE
Registration Number:	2340946	MICROSENSE II
Registration Number:	2351725	DMS
Registration Number:	2413259	DISKMAPPER

### **CORRESPONDENCE DATA**

Fax Number: (781)622-5933

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 7816228930

Email: trademark@mbbp.com

Correspondent Name: Thomas F. Dunn

Address Line 1: 1601 Trapelo Road, Suite 205

Address Line 2: Morse, Barnes-Brown & Pendleton, P.C. Address Line 4: Waltham, MASSACHUSETTS 02451

TRADEMARK
REEL: 004208 FRAME: 0295

0982523

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ATTORNEY DOCKET NUMBER: MICROSENSE / NO CHARGE		
NAME OF SUBMITTER:	Thomas F. Dunn	
Signature:	/Thomas F. Dunn/	
Date:	05/18/2010	
Total Attachments: 11 source=Trademark Recordation Cover Sheet source=Trademark Recordation Cover Sheet source=Microsense_assignment (M012598)	et (M0178138)#page2.tif 6)#page1.tif 6)#page2.tif 6)#page3.tif 6)#page4.tif 6)#page5.tif 6)#page6.tif 6)#page6.tif 6)#page7.tif 6)#page8.tif	

TRADEMARK REEL: 004208 FRAME: 0296

Assignment Page 1 of 2

# TRADEMARK ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNS THE ENTIRE INTEREST AND THE GOODWILL

## **CONVEYING PARTY DATA**

Name	Formerly	Execution Date	Entity Type
KLA-Tencor Corporation		11/12/2009	CORPORATION: DELAWARE

## **RECEIVING PARTY DATA**

Name:	MicroSense Holdings LLC	
Street Address:	1 Van DeGraaff Drive	
City:	Burlington	
State/Country:	MASSACHUSETTS	
Postal Code:	01803	
Entity Type:	LIMITED LIABILITY COMPANY: DELAWARE	

### PROPERTY NUMBERS Total: 4

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**Phone**: 781 622 5930

Email: trademark@mbbp.com
Correspondent Name: Thomas F. Dunn

Address Line 1: 1601 Trapelo Road, Suite 205

Assignment Page 2 of 2

Address Line 2:	Morse, Barnes-Brown & Pendle	ton, P.C.
Address Line 4:	Waltham, MASSACHUSETTS	02451

ATTORNEY DOCKET NUMBER:	MICROSENSE TM ASSIGNMENTS
NAME OF SUBMITTER:	Thomas F. Dunn
Signature:	/Thomas F. Dunn/
Date:	11/25/2009

# **Total Attachments: 9**

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# RECEIPT INFORMATION

ETAS ID: TM158334

Receipt Date: 11/25/2009

Fee Amount: \$115

#### INTELLECTUAL PROPERTY ASSIGNMENT

Dated: November 12, 2009

WHEREAS, KLA-Tencor Corporation, a Delaware corporation located at One Technology Drive, Milpitas, CA 95035 ("KLA"), is the owner of certain intellectual property as set forth in Schedule 1 hereto (the "ATI IP"):

WHEREAS, pursuant to a Stock Purchase Agreement dated as of November 12, 2009 (the "Purchase Agreement") between (1) KLA and (2) MicroSense Holdings, LLC (the "Purchaser"), KLA has sold to Purchaser, and Purchaser has purchased, all of the outstanding capital stock of ADE Technologies, Inc., a Massachusetts corporation ("ATI") (such sale, the "Stock Sale");

WHEREAS, various intellectual property assets related to the operation of the business of ATI are currently owned by KLA; and

WHEREAS, MicroSense, LLC ("Assignee") and KLA are entering into this Assignment in connection with the transactions contemplated by the Purchase Agreement,

WHEREAS, immediately upon the consummation of the Stock Sale, ATI, with the consent of Purchaser, has assigned all of its assets, liabilities, rights and obligations to Assignee, and Assignee has assumed all such assets, liabilities, rights and obligations, pursuant to an assignment agreement of even date herewith, such that Assignee is the successor to the business previously operated by ATI, and

WHEREAS, Purchaser has therefore requested that, in connection with the Stock Sale, KLA execute this Assignment to confirm its full and outright assignment of all of KLA's present and future intellectual property rights in the ATI IP, and Assignee wishes to enter into this Assignment.

NOW, THEREFORE, in exchange for good and valuable consideration (including without limitation the benefits to KLA of completing the Stock Sale, for which this Assignment is a required condition precedent), the receipt and sufficiency of which is hereby acknowledged, KLA does hereby sell, assign, and transfer unto Assignee, KLA's entire right, title and interest in and to said ATI IP, as well as any divisions, continuations in whole or in part, reissues, reexaminations and any foreign counterparts thereto, and including any and all improvements and inventions disclosed in, applications based upon, and patents granted upon (including foreign patents and the right to claim priority), the above-referenced ATI IP, to be held and enjoyed by Assignee, its successors, legal representatives and assigns. KLA hereby additionally agrees to

TRADEMARK REEL: 004208 FRAME: 0299 execute all papers and documents and perform any acts which are reasonably necessary in connection with the prosecution of said ATI IP, as well as any derivative applications thereof and foreign applications based thereon. Furthermore, KLA hereby agrees that the terms, covenants and conditions of this assignment shall inure to the benefit of Assignee, its successors, assigns and other legal representatives, and shall be binding upon KLA, as well as KLA's heirs, legal representatives and assigns. KLA warrants and represents that it has not entered and will not enter into any assignment, contract, or understanding that conflicts with this assignment. This Assignment shall not include the right to seek or collect past damages accruing prior to the date of execution of this Assignment.

IN WITNESS WHEREOF the parties, intending to be bound hereby, have caused this Assignment to be executed and delivered as of the date and year first above written.

SIGNED FOR AND ON BEHALF OF KLA-TENCOR CORPORATION	
Muly ROL	
Name: Mark P. Dentinger	
Title: Executive Vice President and	_
Chief Financial Officer	_
In the presence of:	WITNESS Print Name: Jeffrey S. Eisenberg
SIGNED FOR AND ON BEHALF OF MICROSENSE, LLC	
Name:	
Title:	
In the presence of:	WITNESS
	Print Name:

IN WITNESS WHEREOF the parties, intending to be bound hereby, have caused this Assignment to be executed and delivered as of the date and year first above written.

SIGNED FOR AND ON BEHALF OF KLA-TENCOR CORPORATION	
Name:	
Title:	•
In the presence of:	
	WITNESS Print Name:
SIGNED FOR AND ON BEHALF OF MICROSENSE, LLC	
Domos Veluvi	
Name: JAMES A. PELUST Title: MANAGING DIPECTOR	
In the presence of:	WITNESS Print Name: Kow M Jahnson

# SCHEDULE 1

# 1. Assigned Patents and Patent Applications:

1. US Granted 09/119,803  Japan Granted JP1999-201,943  2. US Granted 09/621,191  EP Published 01 914690.1  3. US Granted JP2001-218885  4. EP Pending 01 273870.4  Japan Granted JP2002-568,133  Thailand Pending 69406  US Granted 10/029,753  5. US Granted 09/896,265  EP Granted 2739999.7  Japan Pending JP2003-509,248  Malaysia Granted P1 2002 002476  Thailand Pending 74900  6. US Granted 09/795,880  EP Pending 02 713703.3	Family #	Country	Status	A N
Japan   Granted   JP1999-201,943	Family #	Country	Status	AppNumber
2. US Granted 09/621,191  EP Published 01 914690.1  3. US Granted 09/624,570  Japan Granted JP2001-218885  4. EP Pending 01 273870.4  Japan Granted JP2002-568,133  Thailand Pending 69406  US Granted 10/029,753  5. US Granted 09/896,265  EP Granted 2739999.7  Japan Pending JP2003-509,248  Malaysia Granted P1 2002 002476  Thailand Pending 74900  6. US Granted 09/795,880	1.	US	Granted	09/119,803
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Malaysia Granted PI 2002 002476  Thailand Pending 74900  6. US Granted 09/795,880		EP	Granted	2739999.7
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6. US Granted 09/795,880		Malaysia	Granted	PI 2002 002476
6. US Granted 09/795,880		Thailand	Pending	74900
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7.	US	Granted	10/353,889
8.	DE	Pending	10 2004 013 087.6
	Singapore	Granted	200401530-1
	Thailand	Pending	89423
	US	Granted	10/793,605
9.	US	Pending	11/432730
	Singapore	Granted	137757
	Japan	Published	2007-125438
	US	Published	11/692,762

# 2. Assigned Registered Trademarks:

Number	Country	Trademark
1.	US	MICROSENSE
2.	US	MICROSENSE II
3.	US	DISKMAPPER
4.	US	DMS

# 3. Assigned Product Names

Number	Product Name (Capacitance Sensors)
1.	6360 CD
2.	6360 CD
3.	Capacitance™ Sensors
4.	MicroSense® 5430 Gauge Modules
5.	MicroSense® 5430 Gauge Modules
6.	Microsense® II 4810/4800 Gage
7.	Microsense® II 4810/4800 Gage
8.	Microsense® II 5300 Console
9.	Microsense® II 5300 Console
10.	Microsense® II 5800 Gage
11.	Microsense® II 5800 Gage
12.	Microsense® II 5810 Gage
13.	Microsense® II 5810 Gage
14.	Microsense® II 6810 Gauge Module
15.	Microsense® II 6810 Gauge Module
16.	Series 2800 Probes

17.	Series 5000 Probes
18.	Series 5000 Probes
19.	SpinCheck HR
20.	SpinCheck HR
21.	NanoDAQ
22.	SpinCheck
23.	MicroSense Mini
24.	MicroSense II 8810/8800 Gauge

Number	Product Name (Magnetics)
1.	KerrMapper™ VS300
2.	M2 Disk Mapper
3.	Polar Kerr™ Magnetometer
4.	S300/ V300
5.	VSM
6.	EasyVSM
7.	EV1-LNA
8.	EV1-TRQ
9.	EV5
10.	EV7
11.	EV9
12.	EV 11
13.	ET9

14.	EVT9
15.	Model 10 VSM Mark II
16.	X9 MPAS
17.	880 VSM
18.	990 Torque magnetometer
19.	1660 VSM Torque
. 20	Model 4
21.	Model 4 HF
22.	Model 886
23.	Model 8810
24.	Model 10 VSM

# 4. Assigned Domain Names

www.adetech.com www.adetech.jp www.dms-magnetics.com www.ade-magnetics.com